

NSBC114EPDXV6T1, NSBC114EPDXV6T5

Preferred Devices

Dual Bias Resistor Transistors

NPN and PNP Silicon Surface Mount Transistors with Monolithic Bias Resistor Network

The BRT (Bias Resistor Transistor) contains a single transistor with a monolithic bias network consisting of two resistors; a series base resistor and a base-emitter resistor. These digital transistors are designed to replace a single device and its external resistor bias network. The BRT eliminates these individual components by integrating them into a single device. In the NSBC114EPDXV6T1 series, two complementary BRT devices are housed in the SOT-563 package which is ideal for low power surface mount applications where board space is at a premium.

- Simplifies Circuit Design
- Reduces Board Space
- Reduces Component Count
- Available in 8 mm, 7 inch Tape and Reel
- Lead Free Solder Plating

MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted, common for Q₁ and Q₂, – minus sign for Q₁ (PNP) omitted)

Rating	Symbol	Value	Unit
Collector-Base Voltage	V_{CB0}	50	Vdc
Collector-Emitter Voltage	V_{CEO}	50	Vdc
Collector Current	I_C	100	mAdc

THERMAL CHARACTERISTICS

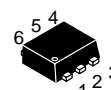
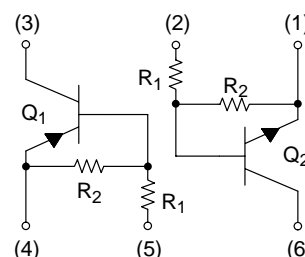
Characteristic (One Junction Heated)	Symbol	Max	Unit
Total Device Dissipation $T_A = 25^\circ\text{C}$	P_D	357 (Note 1)	mW
Derate above 25°C		2.9 (Note 1)	mW/ $^\circ\text{C}$
Thermal Resistance Junction-to-Ambient	$R_{\theta JA}$	350 (Note 1)	$^\circ\text{C}/\text{W}$
Characteristic (Both Junctions Heated)	Symbol	Max	Unit
Total Device Dissipation $T_A = 25^\circ\text{C}$	P_D	500 (Note 1)	mW
Derate above 25°C		4.0 (Note 1)	mW/ $^\circ\text{C}$
Thermal Resistance Junction-to-Ambient	$R_{\theta JA}$	250 (Note 1)	$^\circ\text{C}/\text{W}$
Junction and Storage Temperature	T_J, T_{stg}	-55 to +150	$^\circ\text{C}$

1. FR-4 @ Minimum Pad



ON Semiconductor®

<http://onsemi.com>



SOT-563
CASE 463A
PLASTIC

MARKING DIAGRAM



xx = Specific Device Code
(see table on page 2)
D = Date Code

ORDERING INFORMATION

Device	Package	Shipping
NSBC114EPDXV6T1	SOT-563	4 mm pitch 4000/Tape & Reel
NSBC114EPDXV6T5	SOT-563	2 mm pitch 8000/Tape & Reel

DEVICE MARKING INFORMATION

See specific marking information in the device marking table on page 2 of this data sheet.

Preferred devices are recommended choices for future use and best overall value.

NSBC114EPDXV6T1, NSBC114EPDXV6T5

DEVICE MARKING AND RESISTOR VALUES

Device	Package	Marking	R1 (kΩ)	R2 (kΩ)
NSBC114EPDXV6T1	SOT-563	11	10	10
NSBC124EPDXV6T1	SOT-563	12	22	22
NSBC144EPDXV6T1	SOT-563	13	47	47
NSBC114YPDXV6T1	SOT-563	14	10	47
NSBC114TPDXV6T1 (Note 2)	SOT-563	15	10	∞
NSBC143TPDXV6T1 (Note 2)	SOT-563	16	4.7	∞
NSBC113EPDXV6T1 (Note 2)	SOT-563	30	1.0	1.0
NSBC123EPDXV6T1 (Note 2)	SOT-563	31	2.2	2.2
NSBC143EPDXV6T1 (Note 2)	SOT-563	32	4.7	4.7
NSBC143ZPDXV6T1 (Note 2)	SOT-563	33	4.7	47
NSBC124XPDXV6T1 (Note 2)	SOT-563	34	22	47
NSBC123JPDXV6T1 (Note 2)	SOT-563	35	2.2	47

ELECTRICAL CHARACTERISTICS

(T_A = 25°C unless otherwise noted, common for Q₁ and Q₂, – minus sign for Q₁ (PNP) omitted)

Characteristic	Symbol	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

Collector-Base Cutoff Current (V _{CB} = 50 V, I _E = 0)	I _{CBO}	–	–	100	nAdc
Collector-Emitter Cutoff Current (V _{CE} = 50 V, I _B = 0)	I _{CEO}	–	–	500	nAdc
Emitter-Base Cutoff Current (V _{EB} = 6.0 V, I _C = 0)	I _{EBO}	–	–	0.5	mAdc
	NSBC114EPDXV6T1	–	–	0.2	
	NSBC124EPDXV6T1	–	–	0.1	
	NSBC144EPDXV6T1	–	–	0.2	
	NSBC114YPDXV6T1	–	–	0.9	
	NSBC114TPDXV6T1	–	–	1.9	
	NSBC143TPDXV6T1	–	–	4.3	
	NSBC113EPDXV6T1	–	–	2.3	
	NSBC123EPDXV6T1	–	–	1.5	
	NSBC143EPDXV6T1	–	–	0.18	
	NSBC143ZPDXV6T1	–	–	0.13	
	NSBC124XPDXV6T1	–	–	0.2	
	NSBC123JPDXV6T1	–	–		
Collector-Base Breakdown Voltage (I _C = 10 μA, I _E = 0)	V _{(BR)CBO}	50	–	–	Vdc
Collector-Emitter Breakdown Voltage (Note 3) (I _C = 2.0 mA, I _B = 0)	V _{(BR)CEO}	50	–	–	Vdc

ON CHARACTERISTICS (Note 3)

DC Current Gain (V _{CE} = 10 V, I _C = 5.0 mA)	h _{FE}	35	60	–	
	NSBC114EPDXV6T1	60	100	–	
	NSBC124EPDXV6T1	80	140	–	
	NSBC144EPDXV6T1	80	140	–	
	NSBC114YPDXV6T1	160	350	–	
	NSBC114TPDXV6T1	160	350	–	
	NSBC143TPDXV6T1	3.0	5.0	–	
	NSBC113EPDXV6T1	8.0	15	–	
	NSBC123EPDXV6T1	15	30	–	
	NSBC143EPDXV6T1	80	200	–	
	NSBC143ZPDXV6T1	80	150	–	
	NSBC124XPDXV6T1	80	140	–	
	NSBC123JPDXV6T1				
Collector-Emitter Saturation Voltage (I _C = 10 mA, I _B = 0.3 mA) (I _C = 10 mA, I _B = 5 mA) NSBC113EPDXV6T1/NSBC123EPDXV6T1 (I _C = 10 mA, I _B = 1 mA) NSBC114TPDXV6T1/NSBC143TPDXV6T1 NSBC143EPDXV6T1/NSBC143ZPDXV6T1/NSBC124XPDXV6T1	V _{CE(sat)}	–	–	0.25	Vdc

2. New resistor combinations. Updated curves to follow in subsequent data sheets.
3. Pulse Test: Pulse Width < 300 μs, Duty Cycle < 2.0%

NSBC114EPDXV6T1, NSBC114EPDXV6T5

ELECTRICAL CHARACTERISTICS

(T_A = 25°C unless otherwise noted, common for Q₁ and Q₂, – minus sign for Q₁ (PNP) omitted)

Characteristic	Symbol	Min	Typ	Max	Unit
ON CHARACTERISTICS (Note 3)					
Output Voltage (on) (V _{CC} = 5.0 V, V _B = 2.5 V, R _L = 1.0 kΩ)	V _{OL}	–	–	0.2	Vdc
NSBC114EPDXV6T1		–	–	0.2	
NSBC124EPDXV6T1		–	–	0.2	
NSBC114YPDXV6T1		–	–	0.2	
NSBC114TPDXV6T1		–	–	0.2	
NSBC143TPDXV6T1		–	–	0.2	
NSBC113EPDXV6T1		–	–	0.2	
NSBC123EPDXV6T1		–	–	0.2	
NSBC143EPDXV6T1		–	–	0.2	
NSBC143ZPDXV6T1		–	–	0.2	
NSBC124XPDXV6T1		–	–	0.2	
NSBC123JPDXV6T1		–	–	0.2	
(V _{CC} = 5.0 V, V _B = 3.5 V, R _L = 1.0 kΩ)		–	–	0.2	
NSBC144EPDXV6T1		–	–	0.2	
Output Voltage (off) (V _{CC} = 5.0 V, V _B = 0.5 V, R _L = 1.0 kΩ) (V _{CC} = 5.0 V, V _B = 0.050 V, R _L = 1.0 kΩ) (V _{CC} = 5.0 V, V _B = 0.25 V, R _L = 1.0 kΩ)	V _{OH}	4.9	–	–	Vdc
NSBC113EPDXV6T1					
NSBC114TPDXV6T1					
NSBC143TPDXV6T1					
NSBC143ZPDXV6T1					
Input Resistor	R1	7.0	10	13	k Ω
NSBC114EPDXV6T1		15.4	22	28.6	
NSBC124EPDXV6T1		32.9	47	61.1	
NSBC144EPDXV6T1		7.0	10	13	
NSBC114YPDXV6T1		7.0	10	13	
NSBC114TPDXV6T1		3.3	4.7	6.1	
NSBC143TPDXV6T1		0.7	1.0	1.3	
NSBC113EPDXV6T1		1.5	2.2	2.9	
NSBC123EPDXV6T1		3.3	4.7	6.1	
NSBC143EPDXV6T1		3.3	4.7	6.1	
NSBC143ZPDXV6T1		15.4	22	28.6	
NSBC124XPDXV6T1		1.54	2.2	2.86	
NSBC123JPDXV6T1					
Resistor Ratio	R1/R2	0.8	1.0	1.2	
NSBC114EPDXV6T1/NSBC124EPDXV6T1/NSBC144EPDXV6T1		0.17	0.21	0.25	
NSBC114YPDXV6T1		–	–	–	
NSBC114TPDXV6T1/NSBC143TPDXV6T1		0.8	1.0	1.2	
NSBC113EPDXV6T1/NSBC123EPDXV6T1/NSBC143EPDXV6T1		0.055	0.1	0.185	
NSBC143ZPDXV6T1		0.38	0.47	0.56	
NSBC124XPDXV6T1		0.038	0.047	0.056	
NSBC123JPDXV6T1					

2. New resistor combinations. Updated curves to follow in subsequent data sheets.

3. Pulse Test: Pulse Width < 300 μs, Duty Cycle < 2.0%

NSBC114EPDXV6T1, NSBC114EPDXV6T5

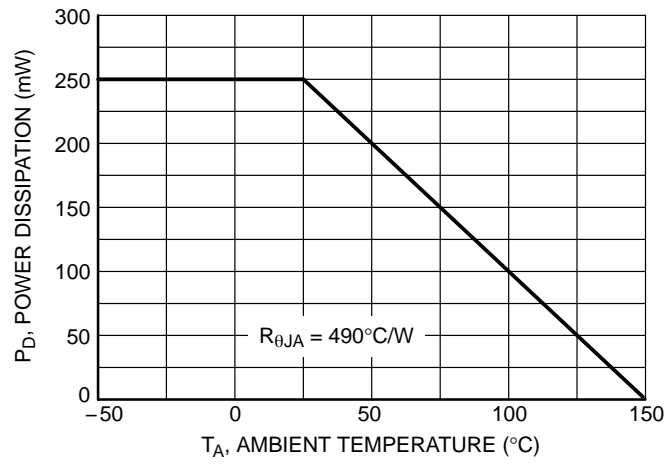


Figure 1. Derating Curve

NSBC114EPDXV6T1, NSBC114EPDXV6T5

TYPICAL ELECTRICAL CHARACTERISTICS – NSBC114EPDXV6T1 NPN TRANSISTOR

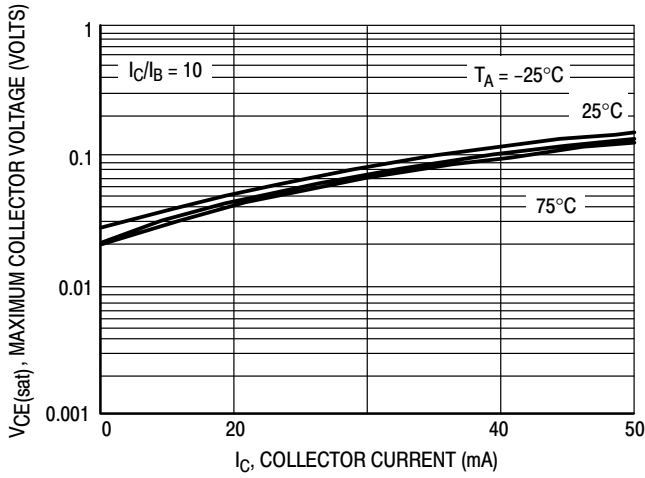


Figure 2. $V_{CE(sat)}$ versus I_C

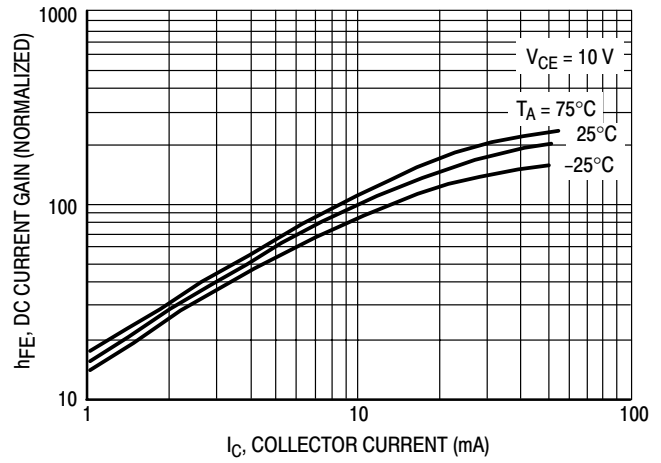


Figure 3. DC Current Gain

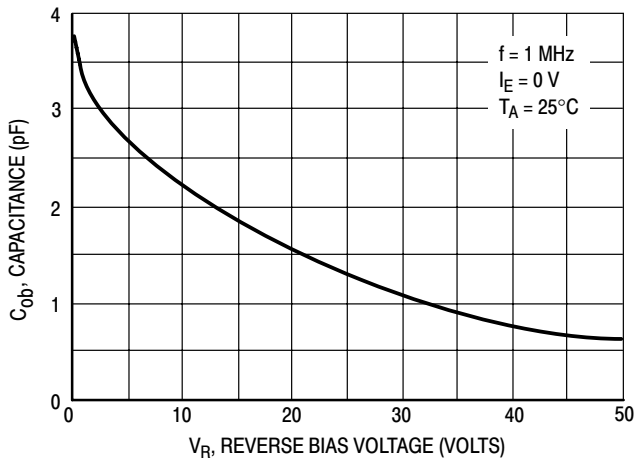


Figure 4. Output Capacitance

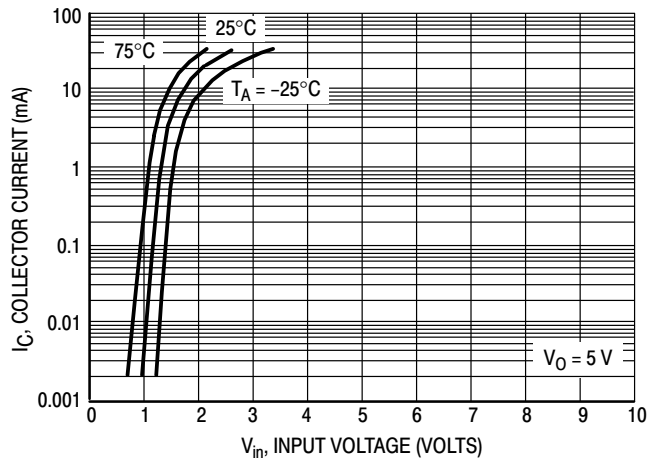


Figure 5. Output Current versus Input Voltage

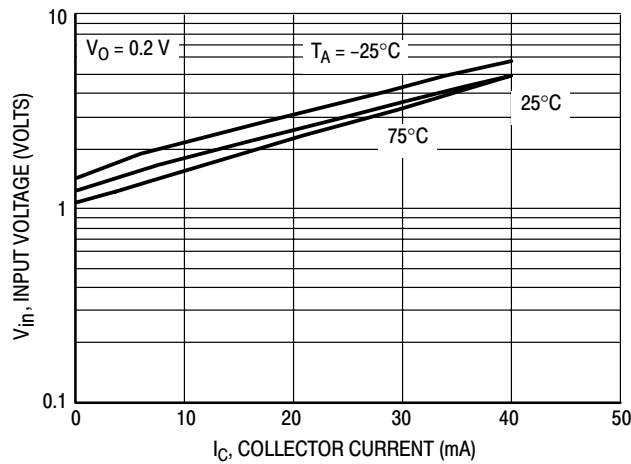


Figure 6. Input Voltage versus Output Current

NSBC114EPDXV6T1, NSBC114EPDXV6T5

TYPICAL ELECTRICAL CHARACTERISTICS – NSBC114EPDXV6T1 PNP TRANSISTOR

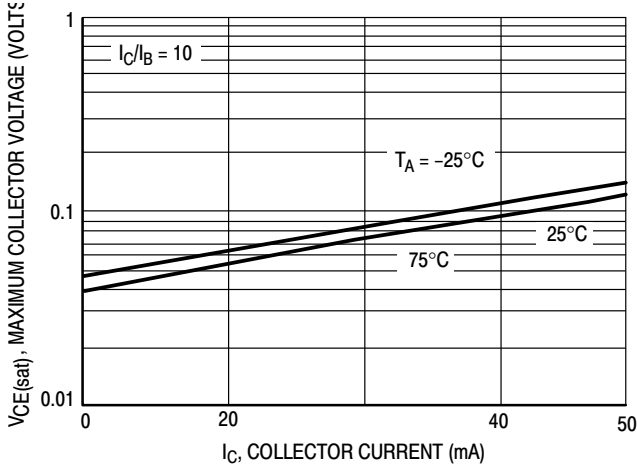


Figure 7. $V_{CE(sat)}$ versus I_C

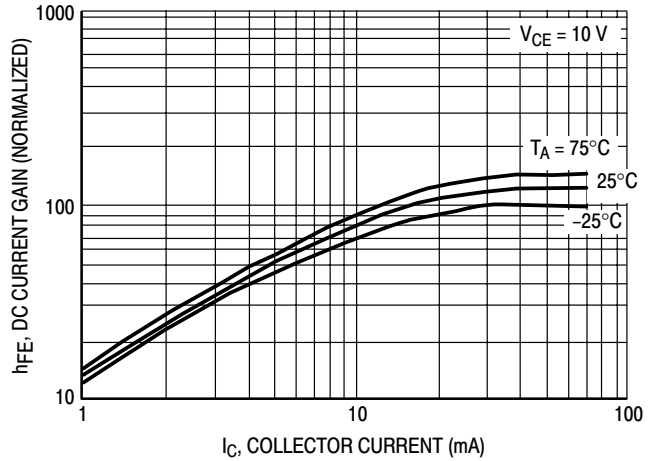


Figure 8. DC Current Gain

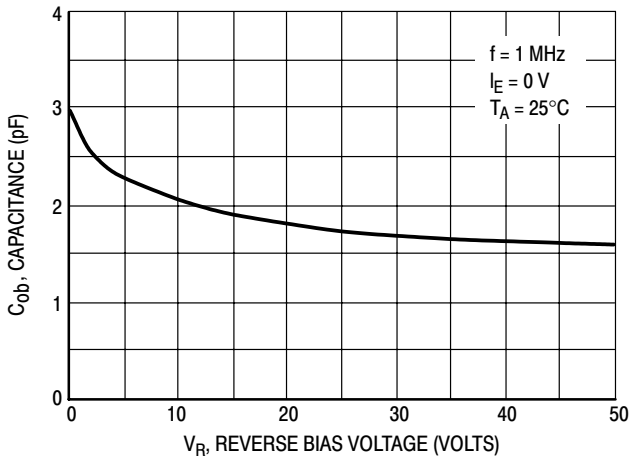


Figure 9. Output Capacitance

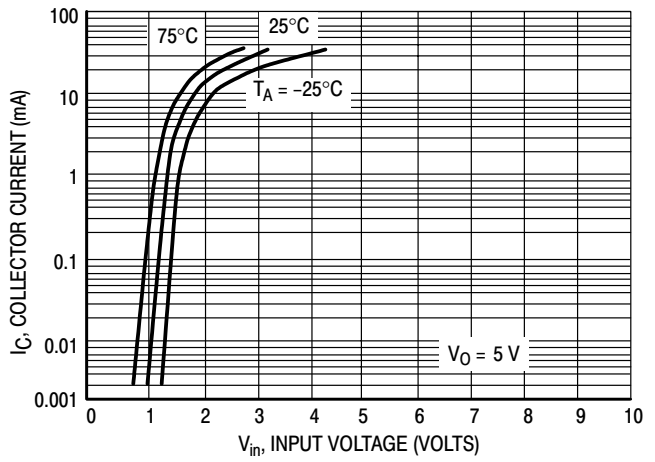


Figure 10. Output Current versus Input Voltage

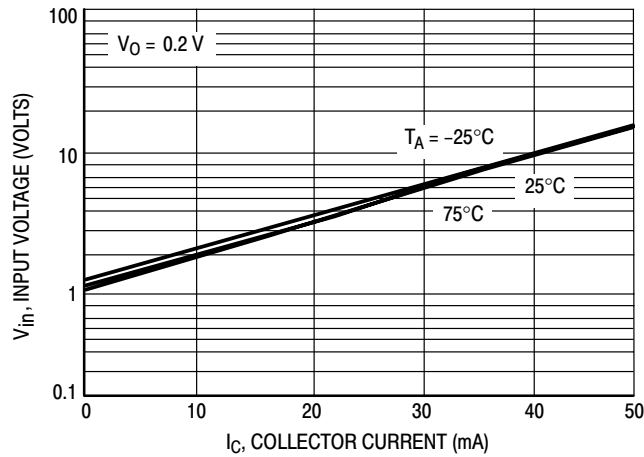


Figure 11. Input Voltage versus Output Current

TYPICAL ELECTRICAL CHARACTERISTICS – NSBC124EPDXV6T1 NPN TRANSISTOR

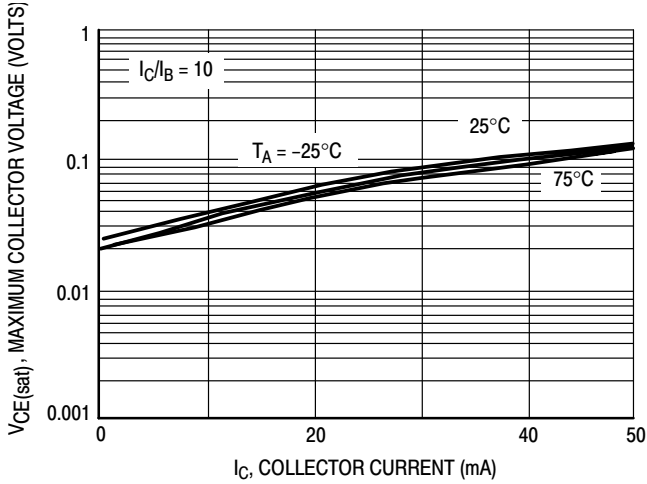


Figure 12. $V_{CE(sat)}$ versus I_C

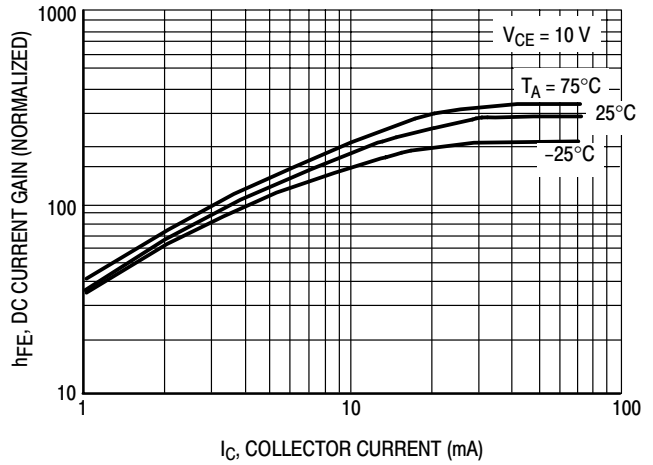


Figure 13. DC Current Gain

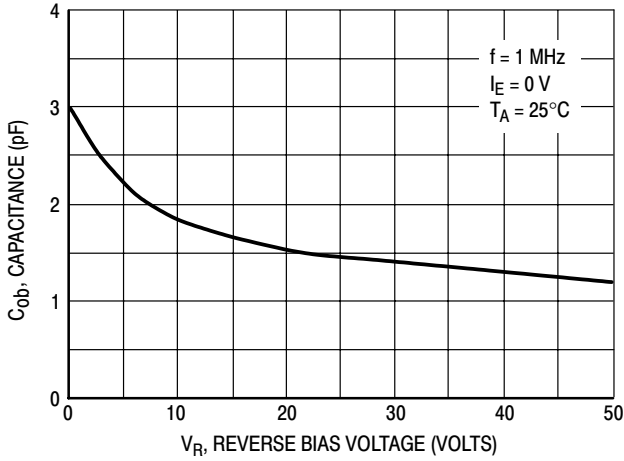


Figure 14. Output Capacitance

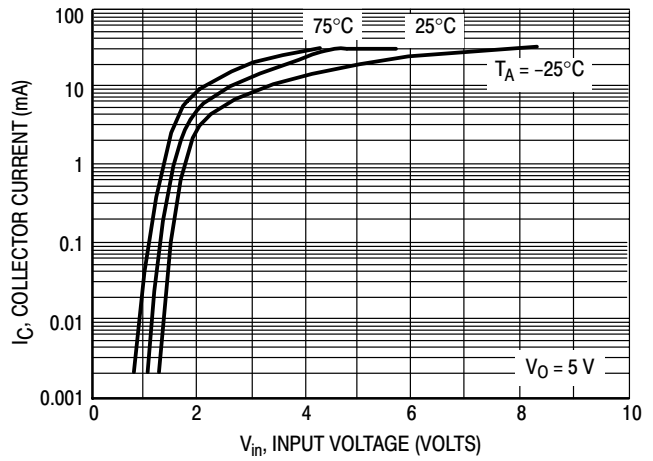


Figure 15. Output Current versus Input Voltage

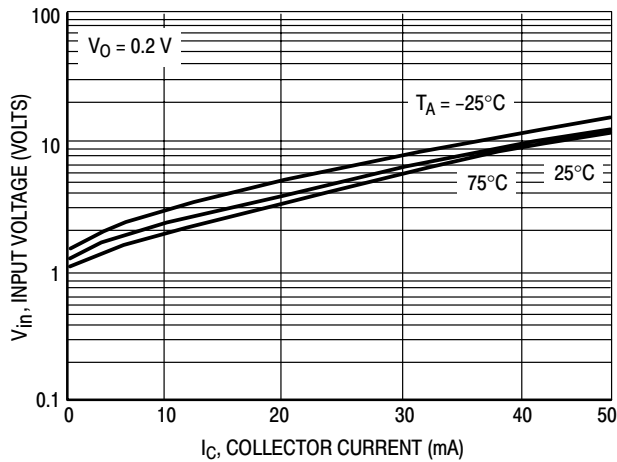


Figure 16. Input Voltage versus Output Current

TYPICAL ELECTRICAL CHARACTERISTICS – NSBC124EPDXV6T1 PNP TRANSISTOR

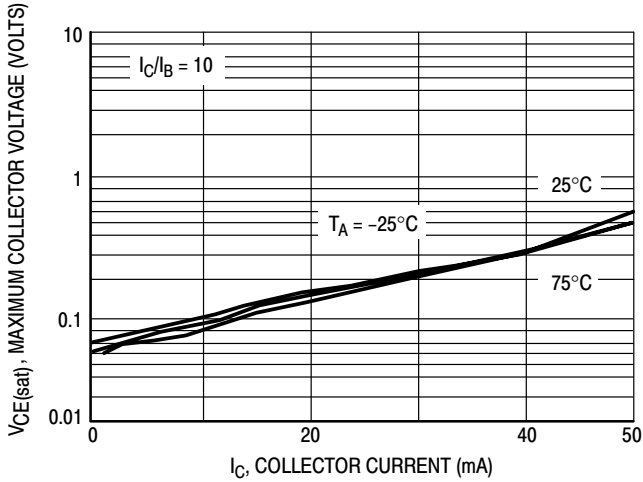


Figure 17. $V_{CE(sat)}$ versus I_C

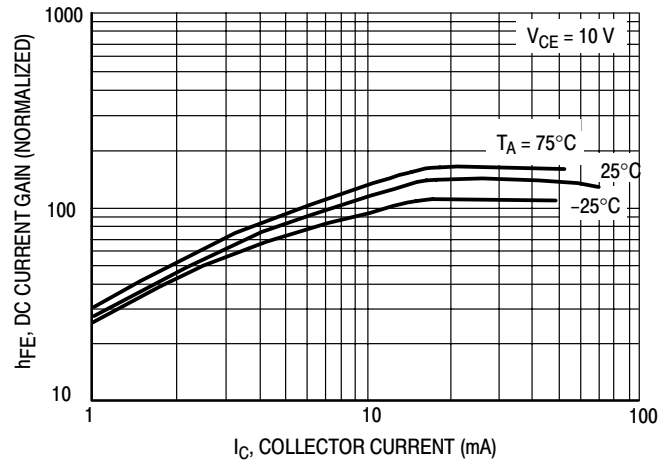


Figure 18. DC Current Gain

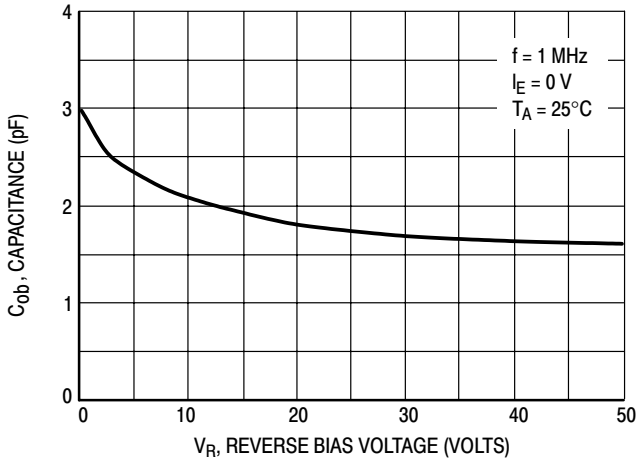


Figure 19. Output Capacitance

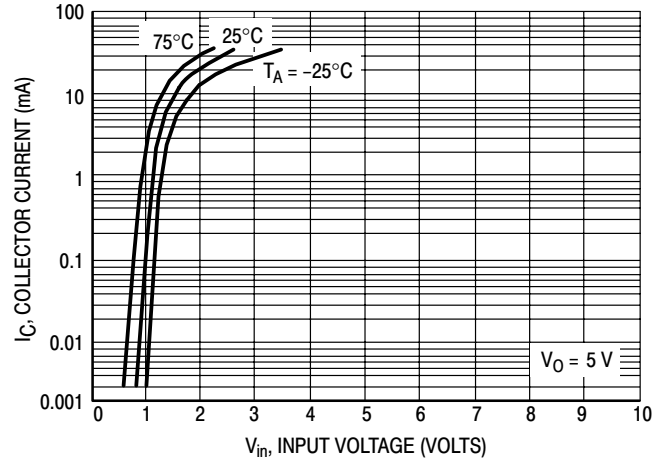


Figure 20. Output Current versus Input Voltage

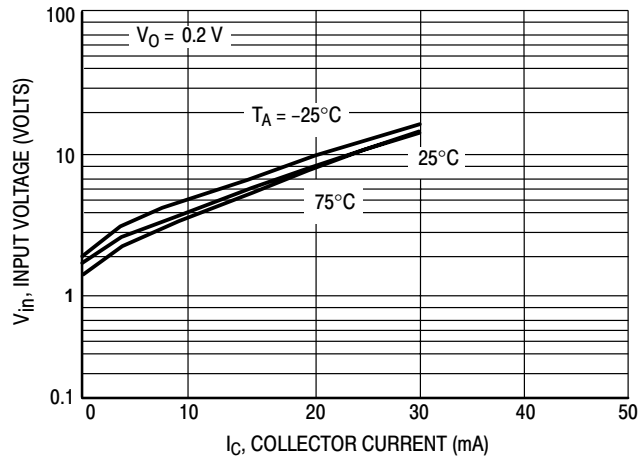


Figure 21. Input Voltage versus Output Current

NSBC114EPDXV6T1, NSBC114EPDXV6T5

TYPICAL ELECTRICAL CHARACTERISTICS – NSBC144EPDXV6T1 NPN TRANSISTOR

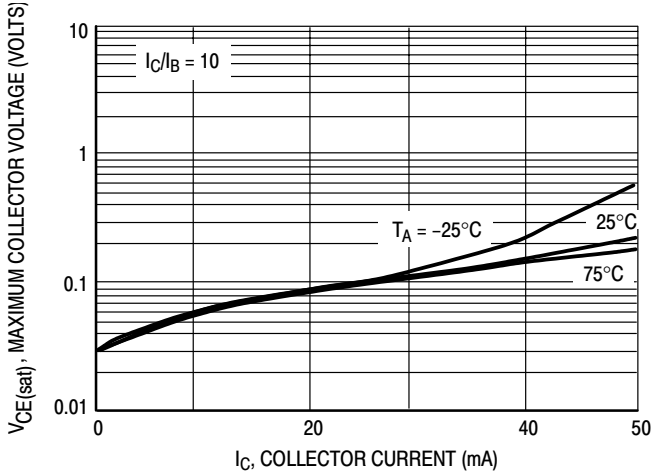


Figure 22. $V_{CE(sat)}$ versus I_C

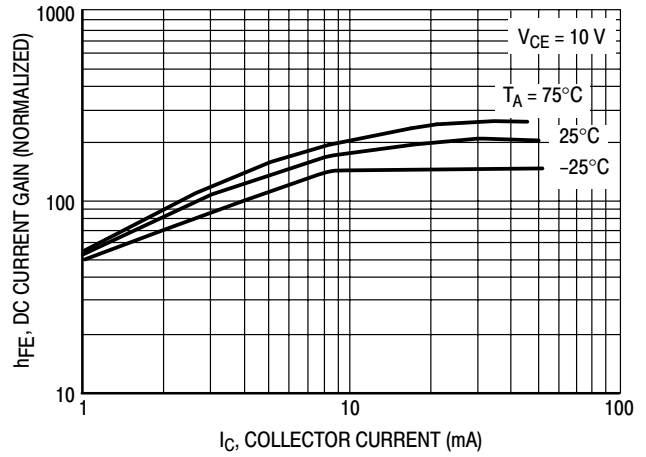


Figure 23. DC Current Gain

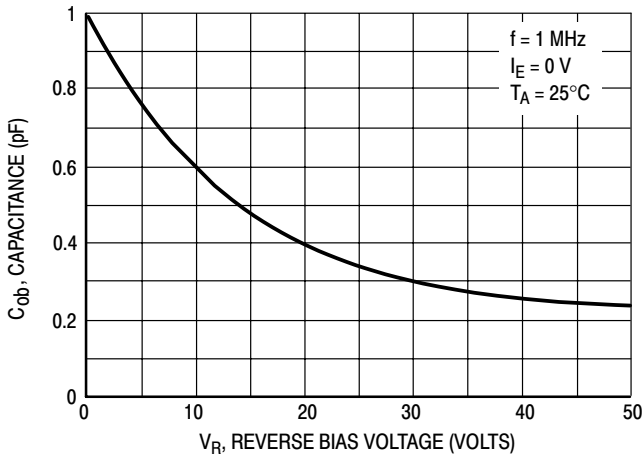


Figure 24. Output Capacitance

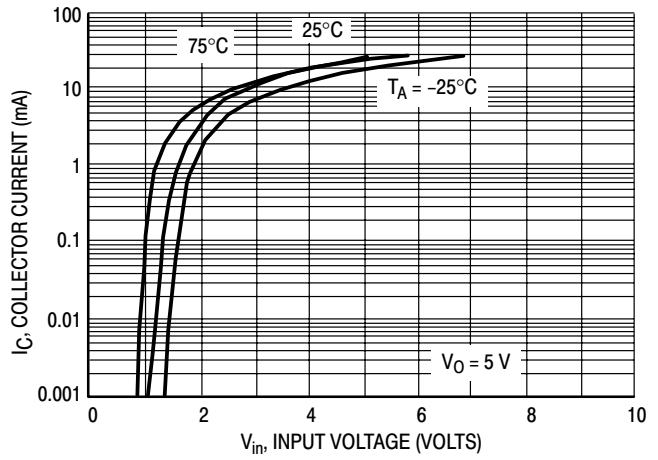


Figure 25. Output Current versus Input Voltage

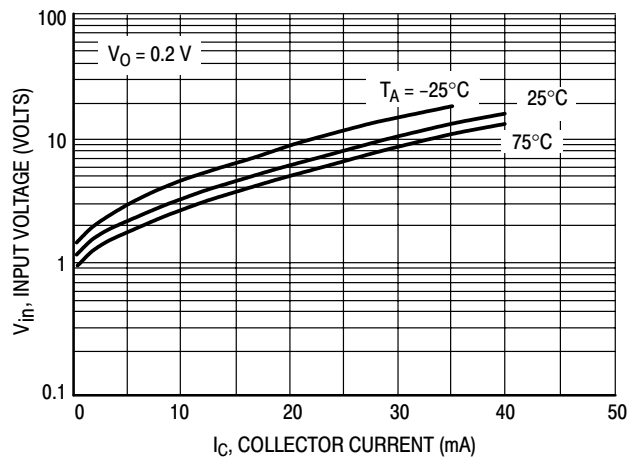


Figure 26. Input Voltage versus Output Current

TYPICAL ELECTRICAL CHARACTERISTICS – NSBC144EPDXV6T1 PNP TRANSISTOR

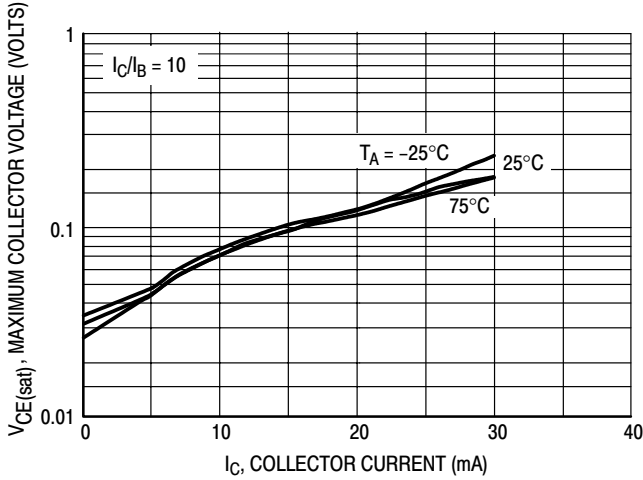


Figure 27. $V_{CE(sat)}$ versus I_C

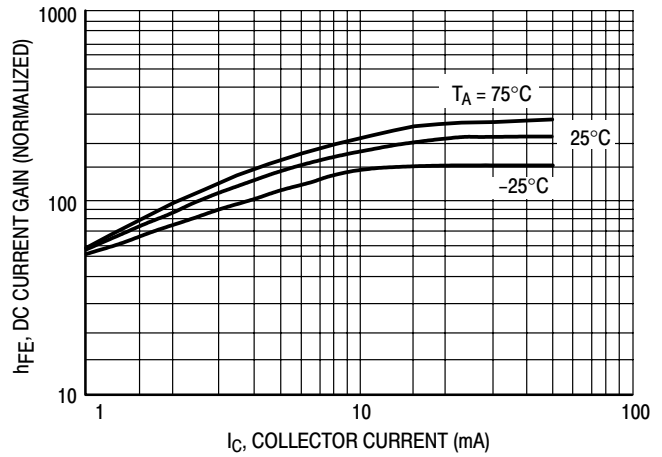


Figure 28. DC Current Gain

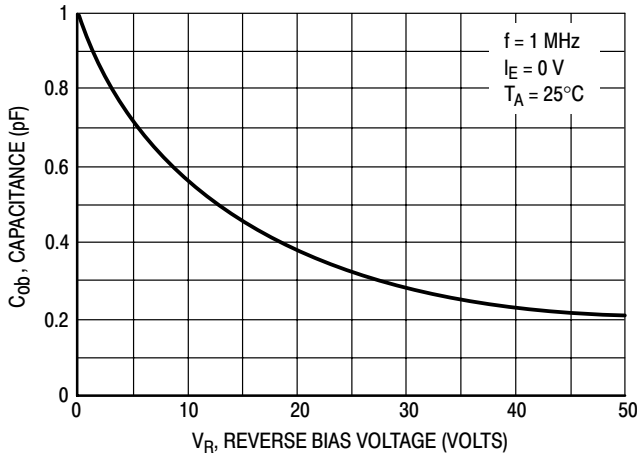


Figure 29. Output Capacitance

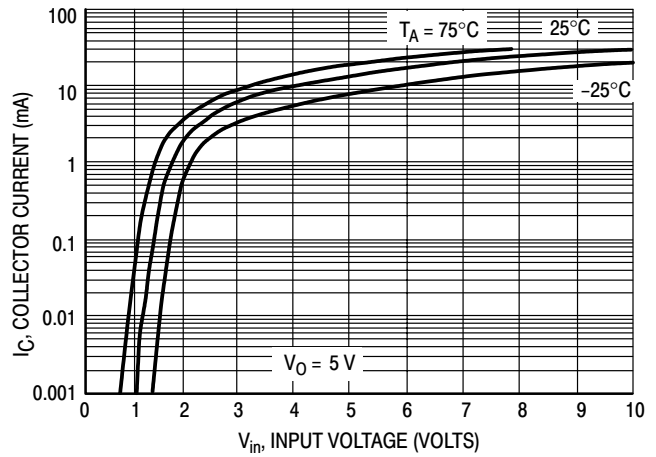


Figure 30. Output Current versus Input Voltage

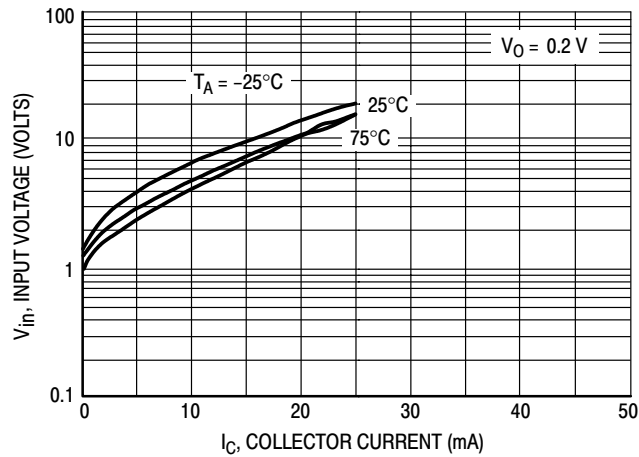


Figure 31. Input Voltage versus Output Current

NSBC114EPDXV6T1, NSBC114EPDXV6T5

TYPICAL ELECTRICAL CHARACTERISTICS – NSBC114YPDXV6T1 NPN TRANSISTOR

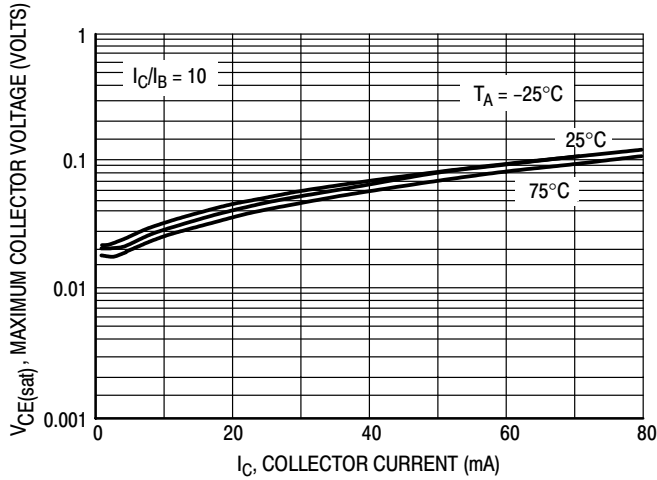


Figure 32. $V_{CE(sat)}$ versus I_C

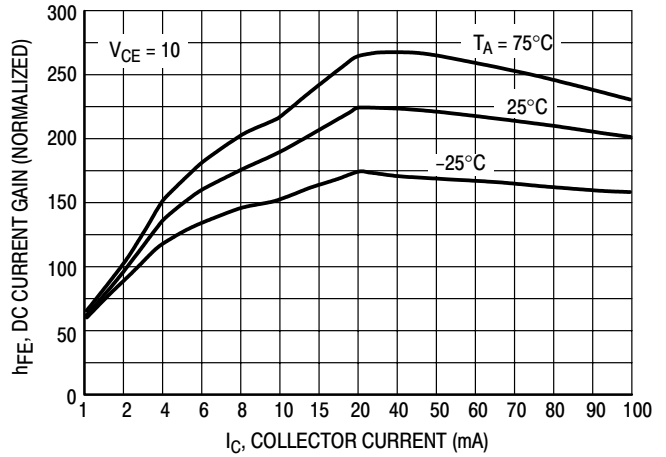


Figure 33. DC Current Gain

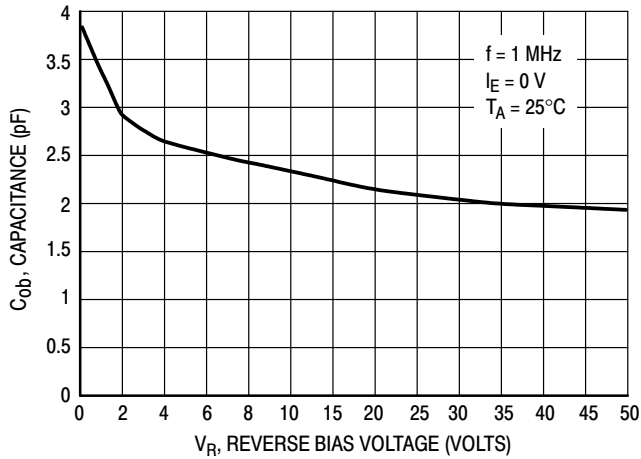


Figure 34. Output Capacitance

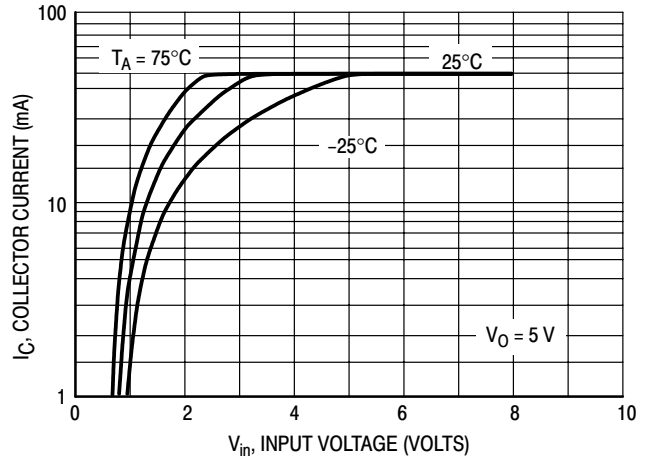


Figure 35. Output Current versus Input Voltage

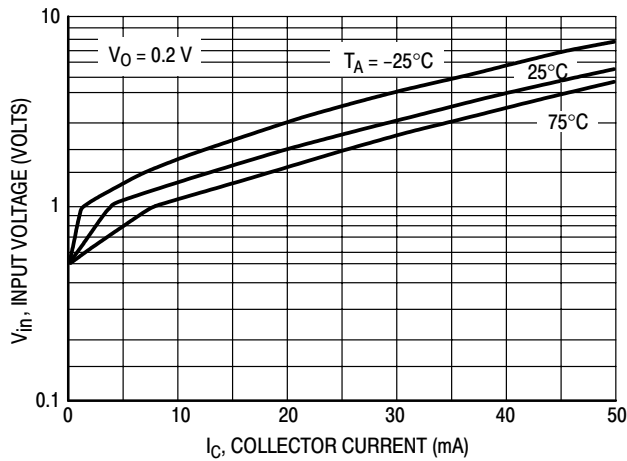


Figure 36. Input Voltage versus Output Current

NSBC114EPDXV6T1, NSBC114EPDXV6T5

TYPICAL ELECTRICAL CHARACTERISTICS – NSBC114YPDXV6T1 PNP TRANSISTOR

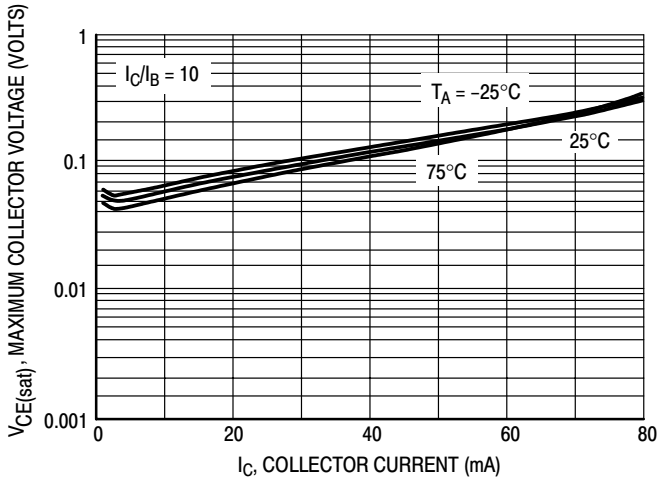


Figure 37. $V_{CE(sat)}$ versus I_C

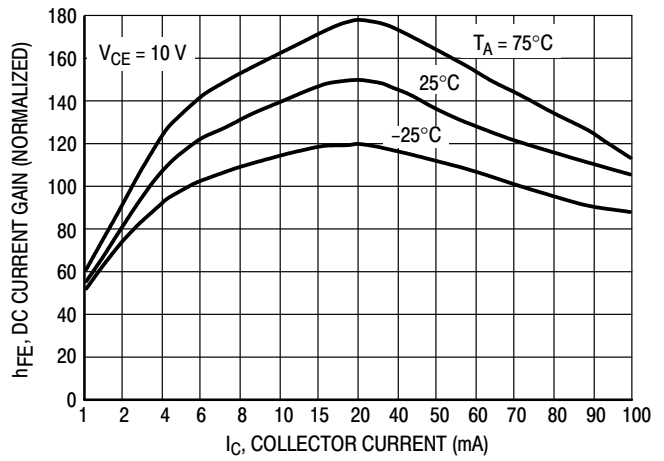


Figure 38. DC Current Gain

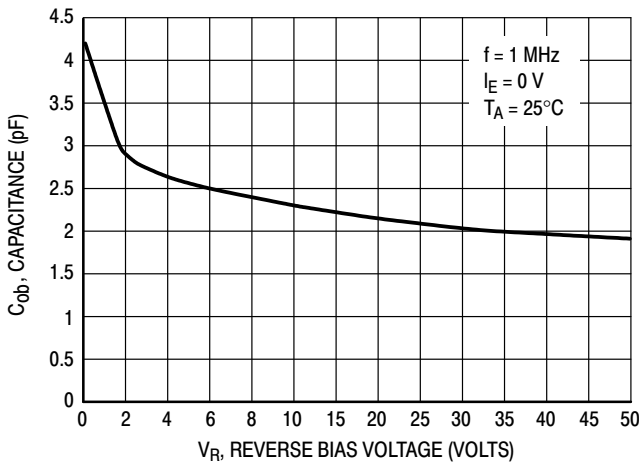


Figure 39. Output Capacitance

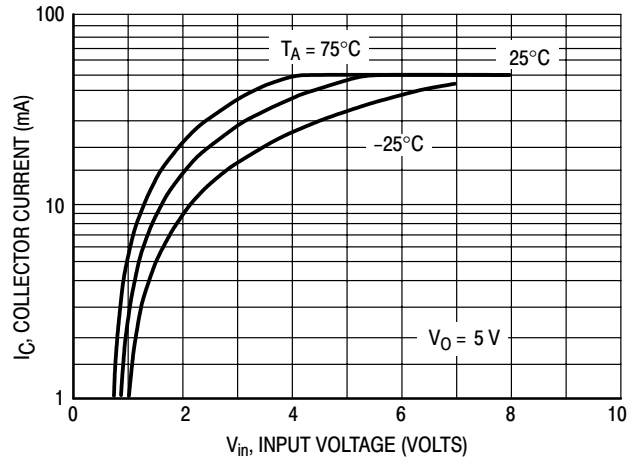


Figure 40. Output Current versus Input Voltage

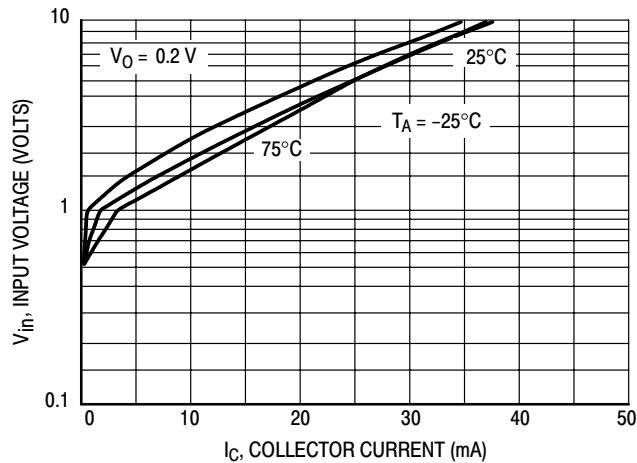


Figure 41. Input Voltage versus Output Current

NSBC114EPDXV6T1, NSBC114EPDXV6T5

TYPICAL ELECTRICAL CHARACTERISTICS – NSBC114TPDXV6T1

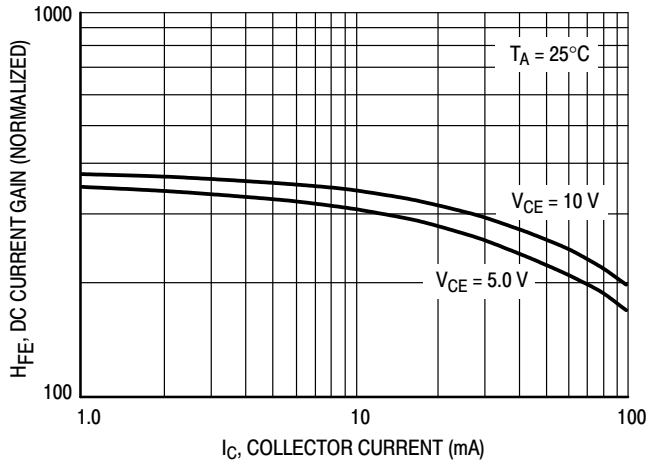


Figure 42. DC Current Gain – PNP

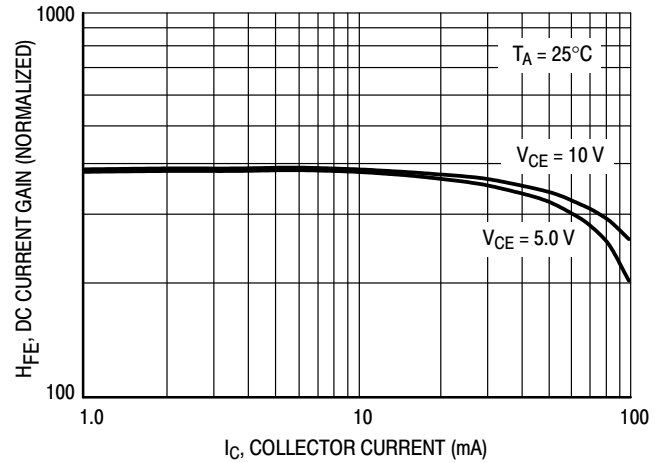


Figure 43. DC Current Gain – NPN

TYPICAL ELECTRICAL CHARACTERISTICS – NSBC143TPDXV6T1

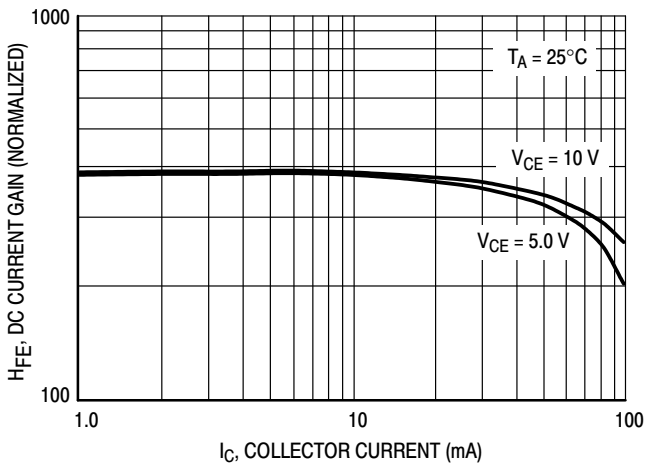


Figure 44. DC Current Gain – PNP

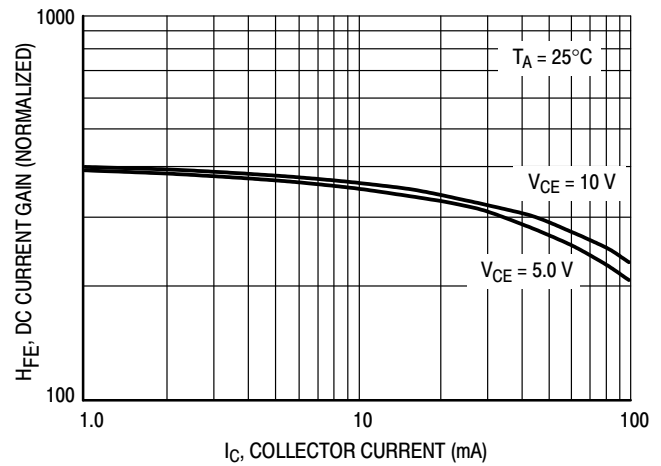
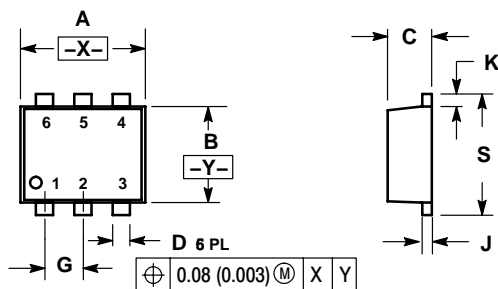


Figure 45. DC Current Gain – NPN

NSBC114EPDXV6T1, NSBC114EPDXV6T5

PACKAGE DIMENSIONS

SOT-563, 6 LEAD
CASE 463A-01
ISSUE O



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETERS
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	1.50	1.70	0.059	0.067
B	1.10	1.30	0.043	0.051
C	0.50	0.60	0.020	0.024
D	0.17	0.27	0.007	0.011
G	0.50 BSC		0.020 BSC	
J	0.08	0.18	0.003	0.007
K	0.10	0.30	0.004	0.012
S	1.50	1.70	0.059	0.067

STYLE 1:

- PIN 1. EMITTER 1
- 2. BASE 1
- 3. COLLECTOR 2
- 4. EMITTER 2
- 5. BASE 2
- 6. COLLECTOR 1

STYLE 2:

- PIN 1. EMITTER 1
- 2. EMITTER 2
- 3. BASE 2
- 4. COLLECTOR 2
- 5. BASE 1
- 6. COLLECTOR 1

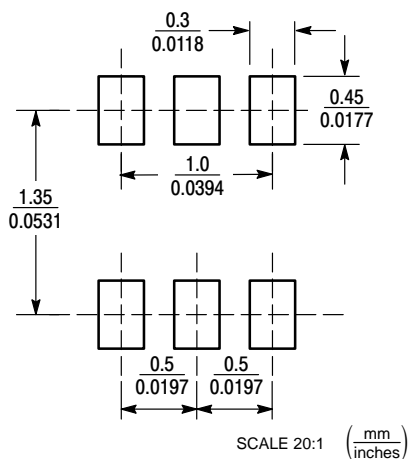
STYLE 3:

- PIN 1. CATHODE 1
- 2. CATHODE 1
- 3. ANODE/ANODE 2
- 4. CATHODE 2
- 5. CATHODE 2
- 6. ANODE/ANODE 1

STYLE 4:

- PIN 1. COLLECTOR
- 2. COLLECTOR
- 3. BASE
- 4. EMITTER
- 5. COLLECTOR
- 6. COLLECTOR

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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